

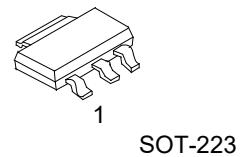
UT5P06H

Power MOSFET

-5.0A, -60V P-CHANNEL
POWER MOSFET

■ DESCRIPTION

The UTC UT5P06H uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch, in PWM applications, converters and power supplies.

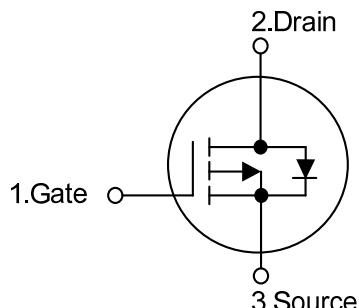


SOT-223

■ FEATURES

- * $R_{DS(ON)} \leq 115 \text{ m}\Omega$ @ $V_{GS} = -10\text{V}$, $I_D = -2.5\text{A}$
- * Low Capacitance
- * Low Gate Charge
- * Fast Switching Capability
- * Avalanche Energy Specified

■ SYMBOL



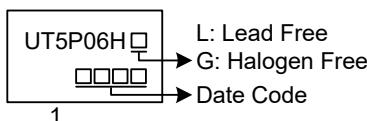
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UT5P06HL-AA3-R	UT5P06HG-AA3-R	SOT-223	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>UT5P06HG-AA3-R</p> <p>(1)Packing Type (2)Package Type (3)Green Package</p>	<p>(1) R: Tape Reel (2) AA3: SOT-223 (3) G: Halogen Free and Lead Free, L: Lead Free</p>
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■ MARKING



1

■ ABSOLUTE MAXIMUM RATINGS ($T_c=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	-60	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current	Continuous	I_D	-5	A
	Pulsed	I_{DM}	-10	A
Avalanche Energy	Single Pulsed	E_{AS}	21	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.1	V/ns
Power Dissipation		P_D	2.3	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature Range		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L = 0.1\text{mH}$, $I_{AS} = -20\text{A}$, $V_{DD} = -50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD} \leq -5.0\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		θ_{JA}	150	$^\circ\text{C}/\text{W}$
Junction to Case		θ_{JC}	54.3	$^\circ\text{C}/\text{W}$

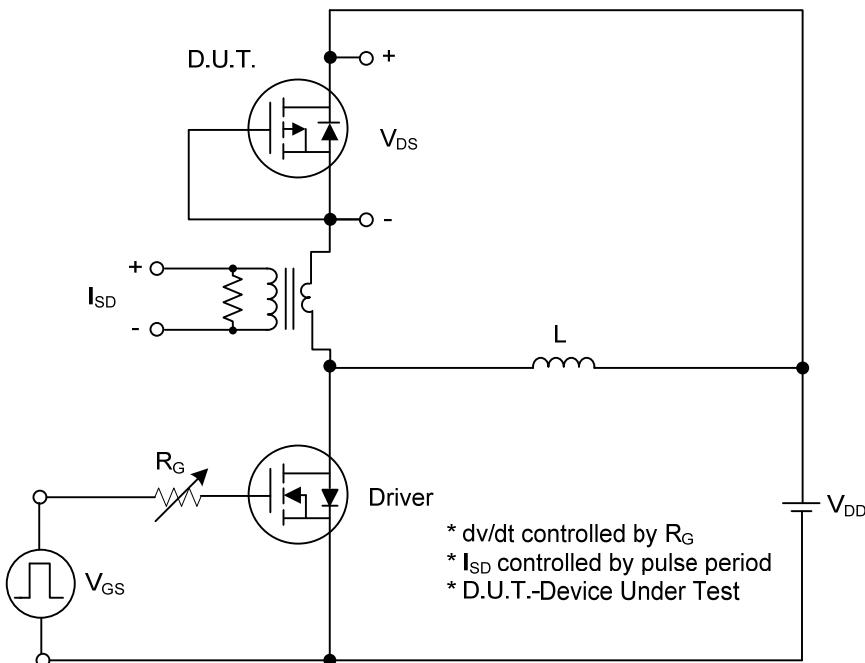
■ ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=-250\mu\text{A}$, $V_{GS}=0\text{V}$	-60			V
Drain-Source Leakage Current	I_{DS}	$V_{DS}=-60\text{V}$, $V_{GS}=0\text{V}$			1	μA
Gate-Source Leakage Current	Forward	I_{GSS}	$V_{GS}=+20\text{V}$, $V_{DS}=0\text{V}$		+100	nA
	Reverse		$V_{GS}=-20\text{V}$, $V_{DS}=0\text{V}$		-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=-250\mu\text{A}$	-2.0		-4.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=-10\text{V}$, $I_D=-2.5\text{A}$			115	$\text{m}\Omega$
DYNAMIC PARAMETERS						
Input Capacitance	C_{iss}	$V_{DS}=-25\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$		787		pF
Output Capacitance	C_{oss}			64		pF
Reverse Transfer Capacitance	C_{rss}			50		pF
SWITCHING PARAMETERS						
Total Gate Charge	Q_G	$V_{DS}=-48\text{V}$, $V_{GS}=-10\text{V}$, $I_D=-5.0\text{A}$ (Note 1, 2)		21		nC
Gate to Source Charge	Q_{GS}			4		nC
Gate to Drain Charge	Q_{GD}			6		nC
Turn-ON Delay Time	$t_{D(ON)}$	$V_{DD}=-30\text{V}$, $V_{GS}=-10\text{V}$, $I_D=-5.0\text{A}$, $R_G=3\Omega$ (Note 1, 2)		6		ns
Rise Time	t_R			18		ns
Turn-OFF Delay Time	$t_{D(OFF)}$			21		ns
Fall-Time	t_F			19		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I_S				-5	A
Maximum Body-Diode Pulsed Current	I_{SM}				-10	A
Drain-Source Diode Forward Voltage	V_{SD}	$I_S=-5.0\text{A}$, $V_{GS}=0\text{V}$			-1.4	V
Reverse Recovery Time	t_{rr}	$I_S=-5.0\text{A}$, $V_{GS}=0\text{V}$		59		ns
Reverse Recovery Charge (Note 1)	Q_{rr}	$dI_S/dt=100\text{A}/\mu\text{s}$		90		nC

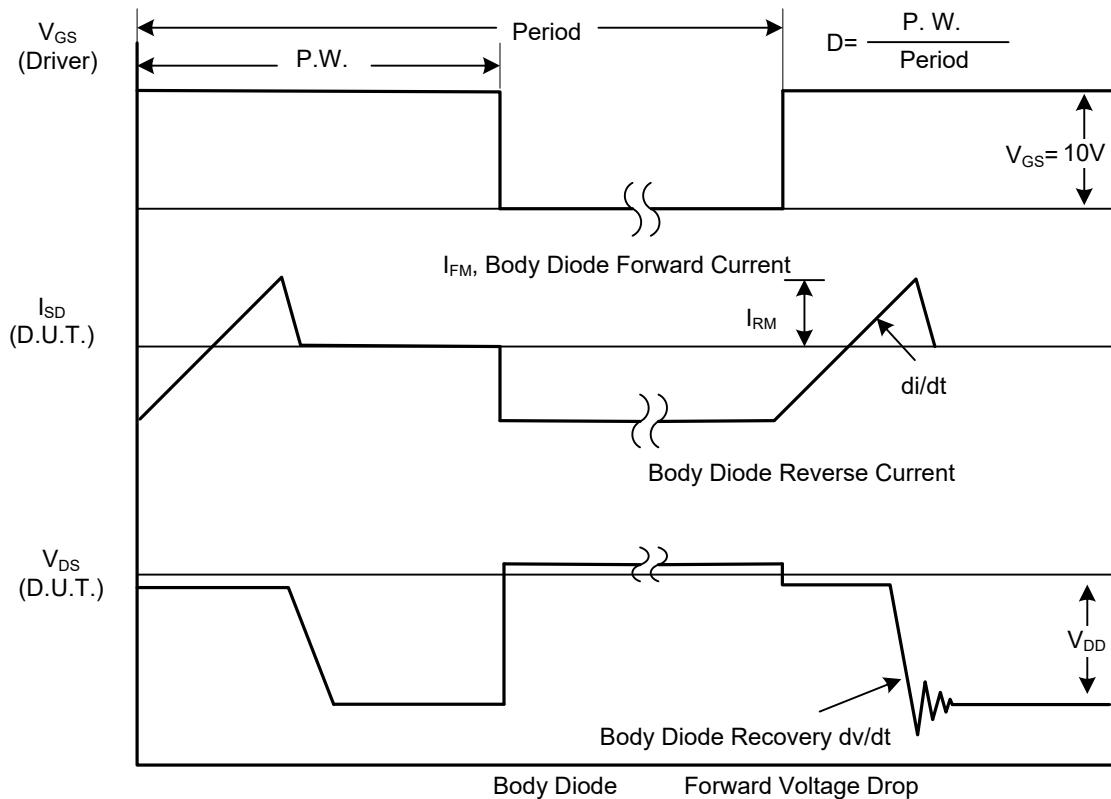
Notes: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating ambient temperature.

■ TEST CIRCUITS AND WAVEFORMS

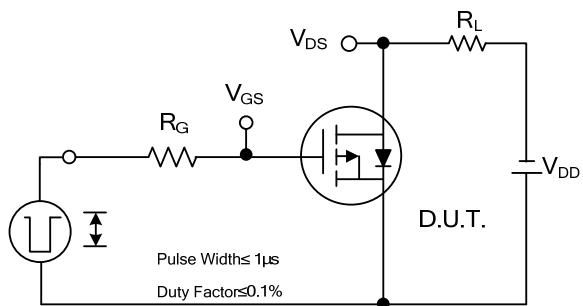


Peak Diode Recovery dv/dt Test Circuit

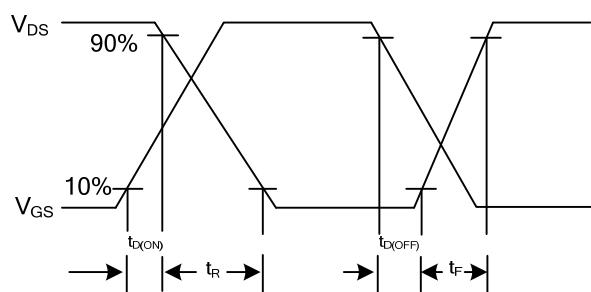


Peak Diode Recovery dv/dt Waveforms

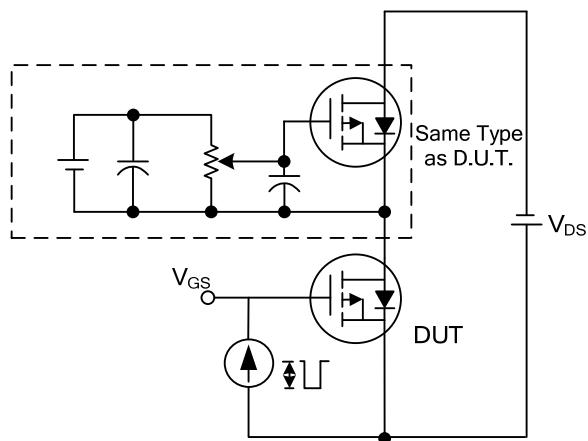
■ TEST CIRCUITS AND WAVEFORMS



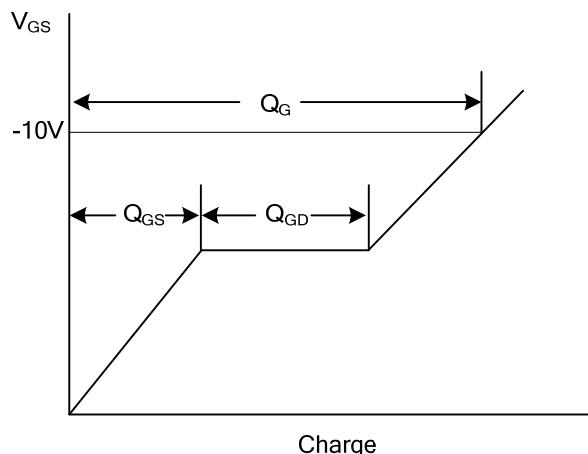
Switching Test Circuit



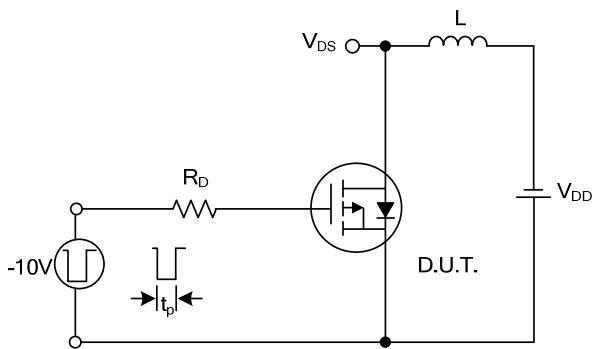
Switching Waveforms



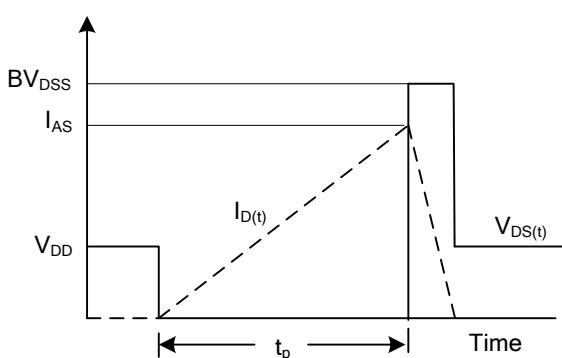
Gate Charge Test Circuit



Gate Charge Waveform

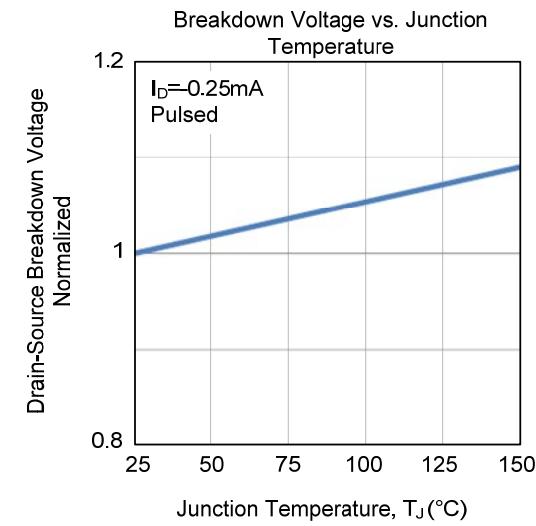
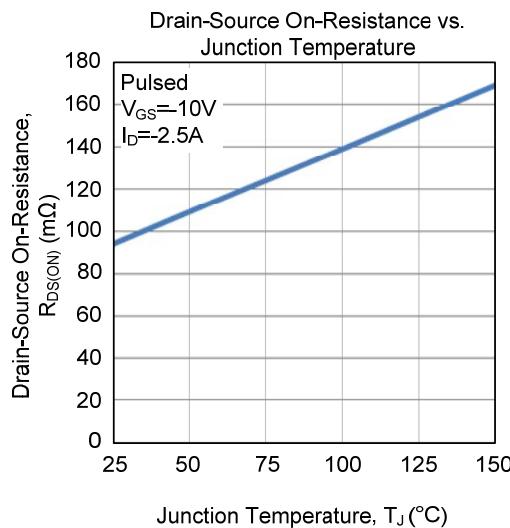
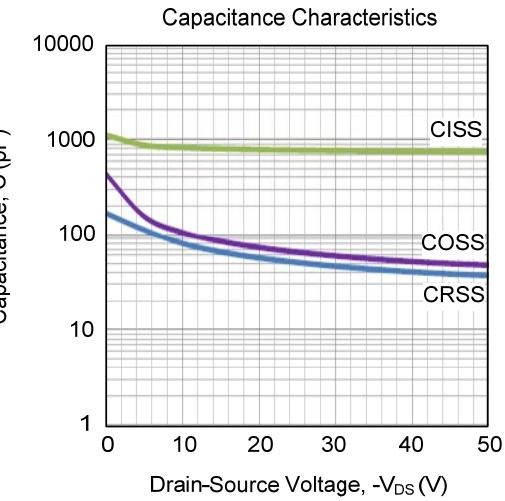
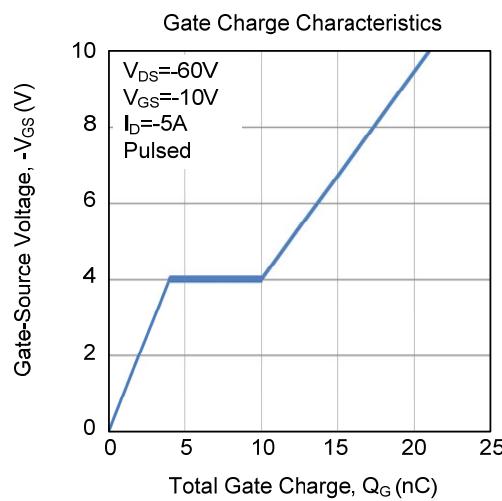
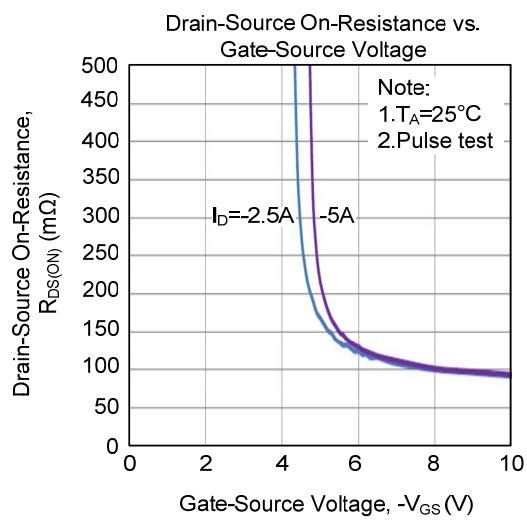
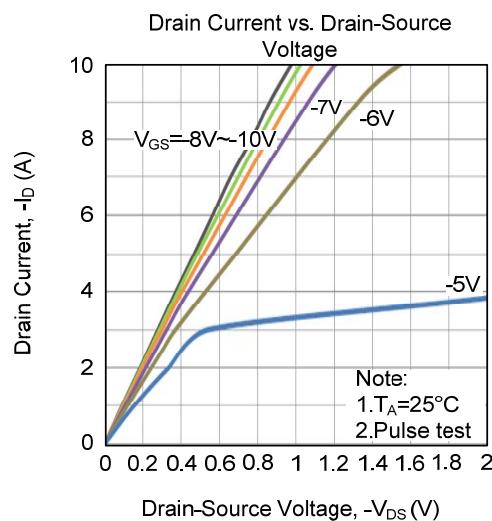


Unclamped Inductive Switching Test Circuit

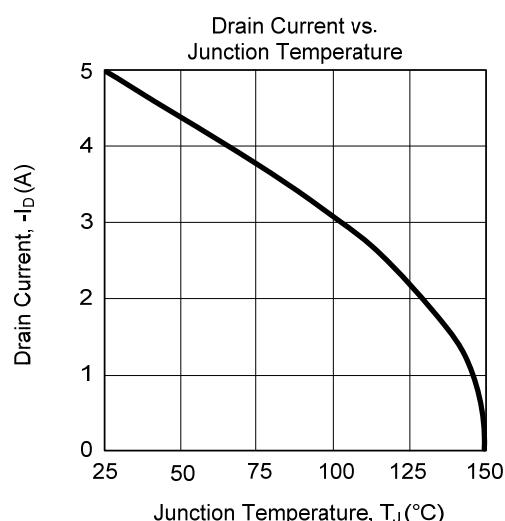
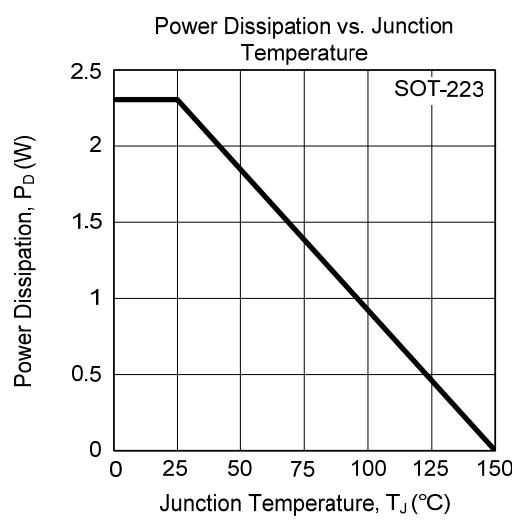
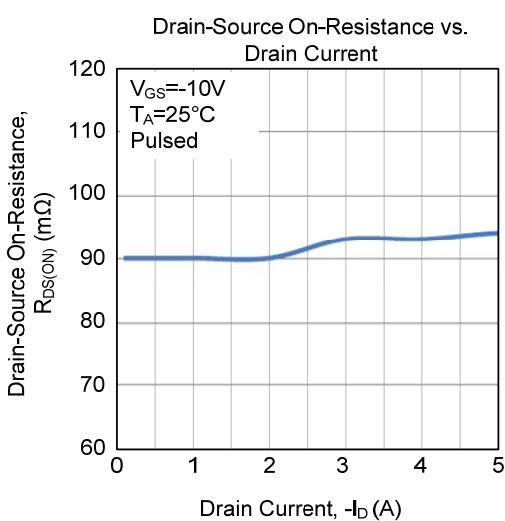
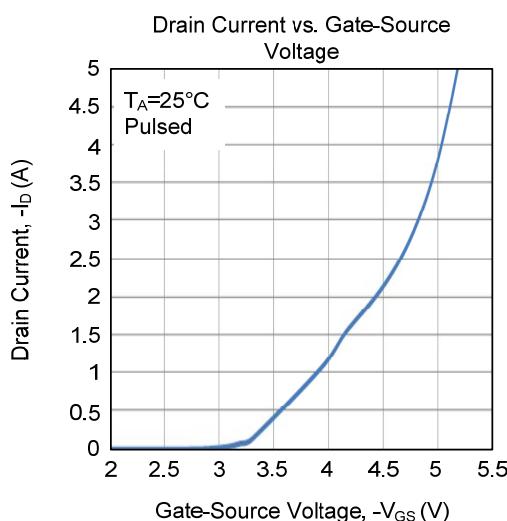
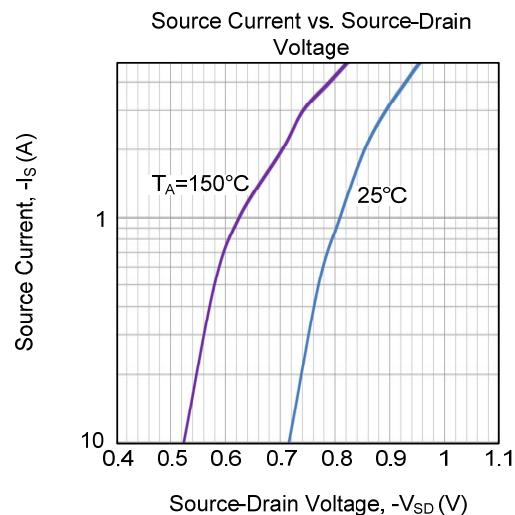
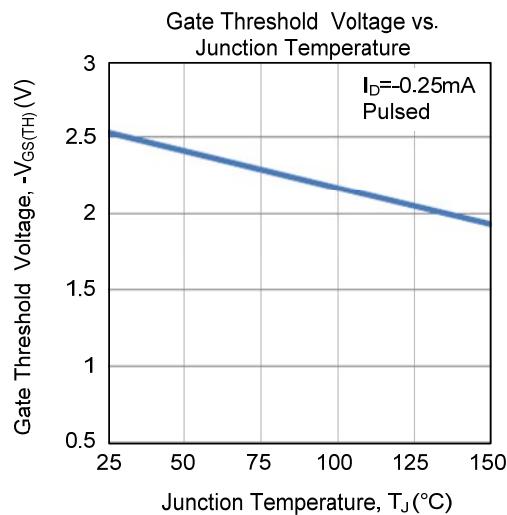


Unclamped Inductive Switching Waveforms

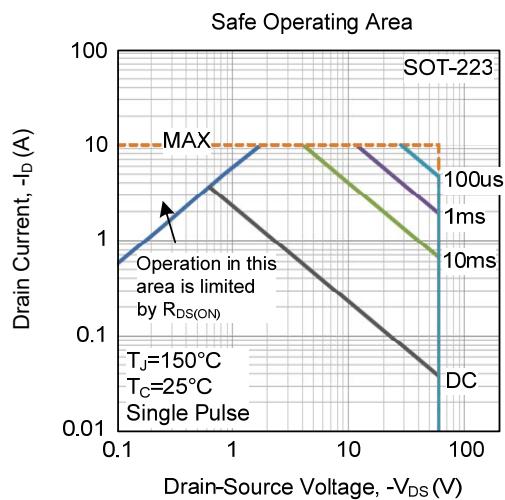
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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